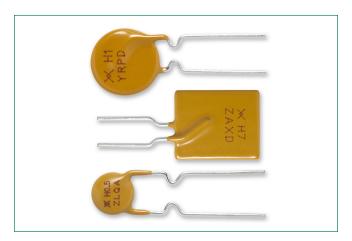
RHEF Series Radial Leaded





Description

Littelfuse PolySwitch radial-leaded devices represent the most comprehensive and complete set of PPTC products available in the industry today. RHEF series offers flatter thermal derating and operating temperatures up to 125°C.

Features & Benefits

- Resettable and single-use overcurrent devices
- Wide range of form factor and termination methods
- Devices compatible with high-volume electronics assembly
- RoHS compliant, Lead-Free and Halogen-Free

Additional Information







Resources

Samples

Applications

- Satellite video receivers
- Industrial controls
- Transformers
- Computer motherboards
- Modems
- USB hubs, ports and peripherals
- IEEE 1394 ports

- CD-ROMs
- Game machines
- Battery packs
- Phones
- Fax machines
- Analog and digital line cards
- Printers

Agency Approvals

Accessories

Agency	Agency File Number
W	E74889
® .	78165
A	72161789

Electrical Characteristics

Part	Ordering Part	I _H	I _T	١	/ _{MAX}	I _M	IAX	P _{D Typ}	Max Tim	e-to-trip	R _{MIN}	R _{MAX}	R _{1MAX}	Lead Size
Number	Number	(A)	(A)	(V _{DC})	(V _{AC RMS})	(DC _{ADC})	(AC _{ARMS}) (W)	(A)	(s)	(Ω)	(Ω)	(Ω)	(mm²/AWG)	
					RHI	EF* – 30V	/ - High Te	mperat	ure					
RHEF050	RF3295-000	0.5	0.9	30	_	40	_	0.9	2.5	2.5	0.480	0.780	1.10	0.205/24
RHEF070	RF3208-000	0.7	1.4	30	_	40	_	1.4	3.5	3.2	0.300	0.540	0.80	0.205/24
RHEF100	RF3300-000	1.0	1.8	30	_	40	_	1.4	5.0	5.2	0.180	0.300	0.43	0.205/24

Notes:

: Hold current: maximum current device will pass without interruption in 20°C still air. : Trip current: minimum current that will switch the device from low resistance to

high resistance in 20°C still air. V_{MAX} : Maximum continuous voltage device can withstand without damage at rated current.

 $I_{\mbox{\scriptsize MAX}}\,\,$: Maximum fault current device can withstand without damage at rated voltage. : Power dissipated from device when in the tripped state in 20°C still air.

 $R_{\mbox{\scriptsize MIN}}$: Minimum resistance of device as supplied at 20°C unless otherwise specified.

R_{MAX}: Maximum resistance of device as supplied at 20°C unless otherwise specified.

R_{1MAX}: Maximum resistance of device when measured one hour post reflow (surface-mount device) or one hour post trip (radial-leaded device) at 20°C unless otherwise specified.

* Electrical characteristics determined at 25°C.



Electrical Characteristics (Cont'd)

Part	Ordering Part	I _H	Ι _τ	١	/ _{MAX}	I,	ЛАХ	\mathbf{P}_{DTyp}	Max Tim	e-to-trip	R _{MIN}	R _{MAX}	R _{1MAX}	Lead Size
Number	Number	(A)	(A)	(V _{DC})	(V _{AC RMS})	(DC _{ADC})	(AC _{ARMS})	(W)	(A)	(s)	(Ω)	(Ω)	(Ω)	(mm²/ AWG)
					RH	EF* – 16	V - High To	empera	ature					
RHEF200	RF3209-000	2.0	3.8	16	_	100	_	1.4	10.0	4.3	0.0450	0.07400	0.1100	0.205/24
RHEF300	RF3304-000	3.0	6.0	16	_	100	_	3.0	15.0	5.0	0.0330	0.05300	0.0790	0.520/20
RHEF400	RF3305-000	4.0	7.5	16	_	100	_	3.3	20.0	5.0	0.0240	0.04000	0.0600	0.520/20
RHEF450	RF3210-000	4.5	7.8	16	_	100	_	3.6	22.5	3.0	0.0220	0.03600	0.0540	0.520/20
RHEF550	RF3309-000	5.5	10.0	16	_	100	_	3.5	27.5	6.0	0.0150	0.02500	0.0370	0.520/20
RHEF600	RF3311-000	6.0	10.8	16	_	100	_	4.1	30.0	5.0	0.0130	0.02150	0.0320	0.520/20
RHEF650	RF3313-000	6.5	12.0	16	_	100	_	4.1	32.5	5.5	0.0110	0.01750	0.0260	0.520/20
RHEF700	RF3316-000	7.0	13.0	16	_	100	_	4.0	35.0	7.0	0.0100	0.01640	0.0250	0.520/20
RHEF750	RF3211-000	7.5	13.1	16	_	100	_	4.5	37.5	7.0	0.0094	0.01530	0.0220	0.520/20
RHEF800	RF3319-000	8.0	15.0	16	_	100	_	4.2	40.0	8.0	0.0080	0.01350	0.0200	0.520/20
RHEF900	RF3320-000	9.0	16.5	16	_	100	_	5.0	45.0	10.0	0.0074	0.01200	0.0170	0.520/20
RHEF1000	RF3321-000	10.0	18.5	16	_	100	_	5.3	50.0	9.0	0.0062	0.01050	0.0150	0.520/20
RHEF1100	RF3323-000	11.0	20.0	16	_	100	_	5.5	55.0	11.0	0.0055	0.00900	0.0130	0.520/20
RHEF1300	RF3324-000	13.0	24.0	16	_	100	_	6.9	65.0	13.0	0.0041	0.00690	0.0100	0.823/18
RHEF1400	RF3326-000	14.0	27.0	16	_	100	_	6.9	70.0	13.0	0.0030	0.00600	0.0090	0.823/18
RHEF1500	RF3060-000	15.0	28.0	16	_	100	_	7.0	75.0	20.0	0.0032	0.00613	0.0092	0.823/18

Notes:

 $\rm I_{\rm H}$: Hold current: maximum current device will pass without interruption in 20°C still air. $\rm I_{\rm T}$: Trip current: minimum current that will switch the device from low resistance to

V_{MAX}: Maximum continuous voltage device can withstand without damage at rated current.

 I_{MAX} : Maximum fault current device can withstand without damage at rated voltage.

 P_{D} : Power dissipated from device when in the tripped state in 20°C still air.

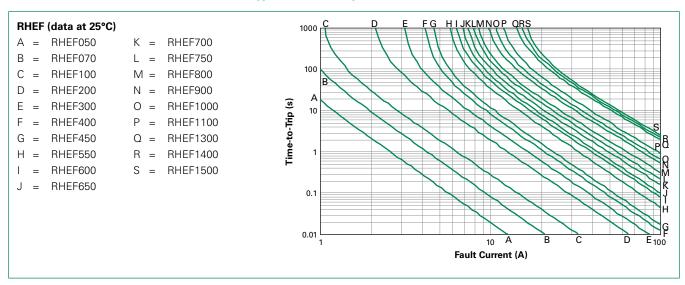
high resistance in 20°C still air.

 $R_{\mbox{\tiny MIN}}\,$: Minimum resistance of device as supplied at 20°C unless otherwise specified.

 $R_{\mbox{\scriptsize MAX}}$: Maximum resistance of device as supplied at 20°C unless otherwise specified.

R_{1MAX}: Maximum resistance of device when measured one hour post reflow (surface-mount device) or one hour post trip (radial-leaded device) at 20°C unless otherwise specified.

Typical Time-to-Trip Curves at 20°C



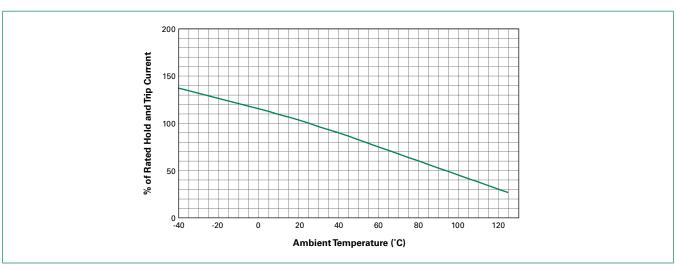


^{*} Electrical characteristics determined at 25°C.

Temperature Rerating

				Maximu	m Ambient	Temperature	e					
	-40°C	-20°C	0°C	20°C	25°C	40°C	50°C	60°C	70°C	85°C	125°C	
	Hold Current (A)											
				RHEF -	30V - High	Temperatu	ıre					
RHEF050	0.68	0.62	0.56	0.51	0.50	0.44	0.40	0.36	0.34	0.28	0.12	
RHEF070	0.95	0.87	0.79	0.72	0.70	0.62	0.56	0.51	0.47	0.39	0.17	
RHEF100	1.36	1.24	1.13	1.03	1.00	0.89	0.80	0.73	0.67	0.56	0.24	
				RHEF -	16V - High	Temperatu	ire					
RHEF200	2.71	2.49	2.26	2.06	2.00	1.77	1.60	1.46	1.34	1.11	0.49	
RHEF300	4.07	3.74	3.41	3.09	3.00	2.65	2.40	2.21	2.00	1.66	0.74	
RHEF400	5.57	5.11	4.65	4.22	4.00	3.62	3.29	3.01	2.73	2.27	1.01	
RHEF450	6.10	5.60	5.10	4.60	4.50	4.00	3.60	3.30	3.00	2.50	1.10	
RHEF550	7.47	6.86	6.24	5.66	5.50	4.85	4.41	4.04	3.66	3.05	1.36	
RHEF600	8.20	7.50	6.80	6.20	6.00	5.30	4.90	4.40	4.00	3.30	1.50	
RHEF650	8.80	8.10	7.40	6.70	6.50	5.70	5.30	4.80	4.30	3.60	1.60	
RHEF700	9.51	8.73	7.95	7.20	7.00	6.17	5.61	5.15	4.66	3.88	1.73	
RHEF750	10.20	9.40	8.60	7.70	7.50	6.60	6.10	5.60	5.00	4.10	1.90	
RHEF800	10.87	9.98	9.08	8.23	8.00	7.06	6.41	5.88	5.33	4.43	1.97	
RHEF900	12.21	11.19	10.16	9.26	9.00	7.97	7.20	6.56	6.04	5.01	2.19	
RHEF1000	13.60	12.50	11.40	10.30	10.00	8.80	8.10	7.40	6.60	5.50	2.50	
RHEF1100	14.94	13.72	12.49	11.31	11.00	9.70	8.82	8.09	7.32	6.09	2.71	
RHEF1300	17.70	16.30	14.80	13.40	13.00	11.40	10.50	9.60	8.60	7.20	3.30	
RHEF1400	19.01	17.46	15.89	14.40	14.00	12.35	11.22	10.29	9.32	7.76	3.45	
RHEF1500	20.40	18.80	17.10	15.50	15.00	13.20	12.10	11.10	9.90	8.30	3.80	

Temperature Rerating Curve





Physical Specifications

Lead Material	RHEF050 to RHEF200: Tin-plated Copper-clad Steel, 0.205mm² (24AWG), ø0.51mm/0.020in RHEF300 to RHEF1100: Tin-plated Copper, 0.52mm² (20AWG), ø0.81mm/0.032in RHEF1300 to RHEF1500: Tin-plated Copper, 0.82mm² (18AWG), ø1.0mm/0.04in
Soldering Characteristics	Solderability per ANSI/J-STD-002 Category 3
Solder Heat Withstand	per IEC 60068-2-20, Test Tb, Method 1; Can withstand 10s at 260°C ±5°C
Insulating Material	Cured, Flame-retardant Epoxy Polymer; Meets UL 94V-0
Operation Temperature	-40°C~125°C

Note: Devices are not designed to be placed through a reflow process.

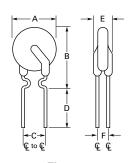
Environmental Specifications

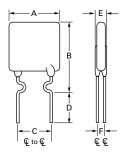
Test	Conditions	Resistance Change
Passive Aging	70°C, 1000 hrs	±5%
rassive Ayilly	85°C, 1000 hrs	±5%
Humidity Aging	85°C, 85% R.H., 1000 hrs	±5%
Thermal Shock	125°C, -40°C (10 Times)	±5%
Solvent Resistance	MIL-STD-202, Method 215F	No change
Moisture Resistance Level	Level 1, J-STD-020	
Storage Conditions	40°C max, 70% RH max; devices should remain	9 9 1

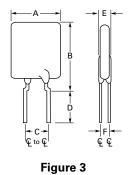
Devices may not meet specified values if these storage conditions are exceeded.



Dimension Figures







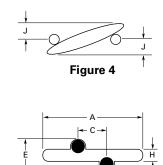


Figure 1

Figure 2

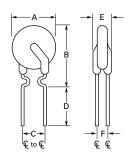
Figure 5

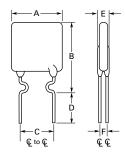
Dimensions and Weights

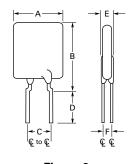
					Dime	ensions	in Millin	neters (I	nches)						
Part Number		A		В	(D)		E	F	Н	J	Figure	Device Mass (g) (Only for Reference)
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Тур	Тур	Тур		
						RHI	EF – 30\	√ - Hig	h Tem	peratur	е				
RHEF050	_	7.4 (0.29)	_	12.7 (0.50)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	_	_	1,4,5	0.177
RHEF070	_	6.9 (0.27)	_	10.8 (0.43)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	1.24 (0.049)	1.2 (0.05)	2,4,5	0.259
RHEF100	_	9.7 (0.38)	_	13.6 (0.54)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	_	_	_	1,4,5	0.312
						RHI	EF – 16\	√ - Hig	h Tem	peratur	е				
RHEF200	_	9.4 (0.37)	_	14.4 (0.57)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.1 (0.12)	_	_	_	1,4,5	0.278
RHEF300	_	8.8 (0.35)	_	13.8 (0.55)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)		_	3,4,5	0.433
RHEF400	_	10.0 (0.39)	_	15.0 (0.59)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	1.24 (0.049)	1.6 (0.06)	3,4,5	0.509
RHEF450	_	10.4 (0.41)	_	15.6 (0.61)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	1.24 (0.049)	1.6 (0.06)	3,4,5	0.605
RHEF550	_	11.2 (0.44)	_	18.9 (0.74)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)		_	3,4,5	0.704
RHEF600	_	11.2 (0.44)	_	21.0 (0.83)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	1.24 (0.049)	1.7 (0.067)	3,4,5	0.792
RHEF650	_	12.7 (0.50)	_	22.2 (0.88)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	1.24 (0.049)	1.8 (0.07)	3,4,5	0.952
RHEF700	_	14.0 (0.55)	_	21.9 (0.86)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	_	_	3,4,5	0.850



Dimension Figures







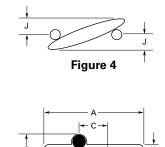


Figure 1 Figure 2

Figure 3

Figure 5

Dimensions and Weights (Cont'd)

					Dime	ensions	in Millin	neters (I	nches)						
Part Number		A		В	C	;	D)		E	F	Н	J	Figure	Device Mass (g) (Only for Reference)
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Тур	Тур	Тур		
						RHI	EF – 16\	/ - Hig	h Tem	peratur	е				
RHEF750	_	14.0 (0.55)	_	23.5 (0.93)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	1.24 (0.049)	2.0 (0.08)	3,4,5	1.054
RHEF800	_	16.5 (0.65)	_	22.5 (0.88)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	_	_	3,4,5	1.073
RHEF900	_	16.5 (0.65)	_	25.7 (1.01)	4.3 (0.17)	5.8 (0.23)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	_	_	3,4,5	1.516
RHEF1000	_	17.5 (0.69)	_	26.5 (1.04)	9.4 (0.37)	10.9 (0.43)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	1.24 (0.049)	1.5 (0.06)	3,4,5	1.791
RHEF1100	_	21.0 (0.83)	_	26.1 (1.03)	9.4 (0.37)	10.9 (0.43)	7.6 (0.30)	_	_	3.0 (0.12)	1.2 (0.05)	_	_	3,4,5	1.570
RHEF1300	_	23.5 (0.925)	_	28.7 (1.13)	9.4 (0.37)	10.9 (0.43)	7.6 (0.30)	_	_	3.6 (0.14)	1.4 (0.06)	1.45 (0.057)	1.9 (0.084)	3,4,5	2.257
RHEF1400	_	23.5 (0.925)	_	28.6 (1.13)	9.4 (0.37)	10.9 (0.43)	7.6 (0.30)	_	_	3.6 (0.14)	1.4 (0.06)	_	_	3,4,5	2.051
RHEF1500	_	23.5 (0.925)	_	28.7 (1.13)	9.4 (0.37)	10.9 (0.43)	7.6 (0.30)	_	_	3.6 (0.14)	1.4 (0.06)	1.45 (0.057)	1.9 (0.084)	3,4,5	2.257

Packaging and Marking Information

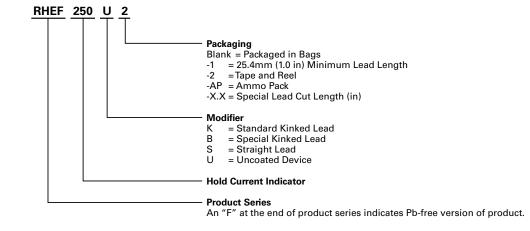
Part Number	Bag Quantity	Tape and Reel Quantity	Ammo Pack Quantity	Standard Package Quantity	Part Marking	Agency Recognition
		RHE	F – 30V - High Te	emperature		
RHEF050	500	_	_	10,000	H0.5	UL, CSA, TÜV
RHEF050-2	_	2,500	_	12,500	H0.5	UL, CSA, TÜV
RHEF070	500	_	_	10,000	H0.7	UL, CSA, TÜV
RHEF070-2	_	2,500	_	12,500	H0.7	UL, CSA, TÜV
RHEF100	500	_	_	10,000	H1	UL, CSA, TÜV
RHEF100-2	_	2,500	_	12,500	H1	UL, CSA, TÜV
		RHE	F – 16V - High Te	emperature		
RHEF200	500	_	_	10,000	H2	UL, CSA, TÜV
RHEF200-2	_	2,500	_	12,500	H2	UL, CSA, TÜV
RHEF200-AP	_	_	2,500	12,500	H2	UL, CSA, TÜV
RHEF300	500	_	_	10,000	H3	UL, CSA, TÜV
RHEF300-2	_	2,000	_	10,000	НЗ	UL, CSA, TÜV
RHEF300-AP	_	_	2,000	10,000	НЗ	UL, CSA, TÜV
RHEF400	500	_	_	10,000	H4	UL, CSA, TÜV
RHEF400-2	_	1,500	_	7,500	H4	UL, CSA, TÜV
RHEF400-AP	_	_	1,500	7,500	H4	UL, CSA, TÜV
RHEF450	500	_	_	10,000	H4.5	UL, CSA, TÜV
RHEF450-2	_	1,500	_	7,500	H4.5	UL, CSA, TÜV
RHEF450-AP	_	_	1,500	7,500	H4.5	UL, CSA, TÜV
RHEF550	500	_	_	10,000	H5.5	UL, CSA, TÜV
RHEF550-2	_	2,000	_	10,000	H5.5	UL, CSA, TÜV
RHEF550-AP	_	_	2,000	10,000	H5.5	UL, CSA, TÜV
RHEF600	500	_	_	10,000	H6	UL, CSA, TÜV
RHEF600-2	_	2,000	_	10,000	H6	UL, CSA, TÜV
RHEF600-AP	_	_	2,000	10,000	H6	UL, CSA, TÜV
RHEF650	500	_	_	10,000	H6.5	UL, CSA, TÜV
RHEF650-2	_	1,500	_	7,500	H6.5	UL, CSA, TÜV
RHEF650-AP	_	_	1,500	7,500	H6.5	UL, CSA, TÜV
RHEF700	500	_	_	10,000	H7	UL, CSA, TÜV
RHEF700-2	_	1,500	_	7,500	H7	UL, CSA, TÜV
RHEF700-AP	_	_	1,500	7,500	H7	UL, CSA, TÜV
RHEF750	500	_	_	10,000	H7.5	UL, CSA, TÜV
RHEF750-2	_	1,000	_	5,000	H7.5	UL, CSA, TÜV
RHEF750-AP	_	_	1,000	5,000	H7.5	UL, CSA, TÜV
RHEF800	500	_	_	10,000	H8	UL, CSA, TÜV
RHEF800-2	_	1,000	_	5,000	H8	UL, CSA, TÜV
RHEF800-AP	_	_	1,000	5,000	Н8	UL, CSA, TÜV



Packaging and Marking Information (Cont'd)

Part Number	Bag Quantity	Tape and Reel Quantity	Ammo Pack Quantity	Standard Package Quantity	Part Marking	Agency Recognition					
RHEF – 16V - High Temperature											
RHEF900	250		_	5,000	H9	UL, CSA, TÜV					
RHEF900-2	_	1,000	_	5,000	H9	UL, CSA, TÜV					
RHEF900-AP	_		1,000	5,000	H9	UL, CSA, TÜV					
RHEF1000	250	_	_	5,000	H10	UL, CSA, TÜV					
RHEF1000-2	_	1,000	_	5,000	H10	UL, CSA, TÜV					
RHEF1000-AP	_	_	1,000	5,000	H10	UL, CSA, TÜV					
RHEF1100	250	_	_	5,000	H11	UL, CSA, TÜV					
RHEF1100-2	_	1,000	_	5,000	H11	UL, CSA, TÜV					
RHEF1100-AP	_	_	1,000	5,000	H11	UL, CSA, TÜV					
RHEF1300	250	_	_	5,000	H13	UL, CSA, TÜV					
RHEF1300-2	_	1,000	_	5,000	H13	UL, CSA, TÜV					
RHEF1300-AP	_	_	1,000	5,000	H13	UL, CSA, TÜV					
RHEF1400	250	_	_	5,000	H14	UL, CSA, TÜV					
RHEF1400-2	_	1,000	_	5,000	H14	UL, CSA, TÜV					
RHEF1400-AP	_	_	1,000	5,000	H14	UL, CSA, TÜV					
RHEF1500	250	_	_	5,000	H15	UL, CSA, TÜV					
RHEF1500-2	_	1,000	_	5,000	H15	UL, CSA, TÜV					
RHEF1500-AP	_	_	1,000	5,000	H15	UL, CSA, TÜV					

Part Ordering Number System



Note: Kinked parts are recommended to control the height of the part on the PCB in non-auto PCB applications.



Tape and Reel Specifications

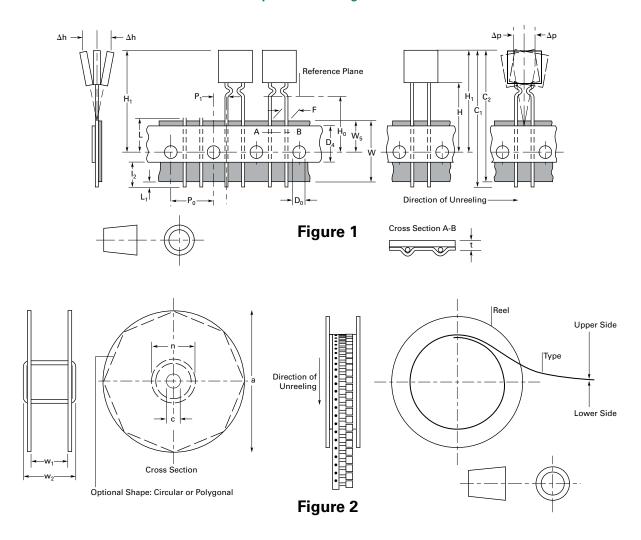
RHEF devices are available in tape and reel packaging per EIA468–B/IEC60286–2 standards. See Figures 1 and 2 for details.

Description	EIA Mark	Dimension (mm)	Tolerance
Carrier Tape Width	W	18	-0.5/+1.0
Hold-Down Tape Width	W_4	11	Minimum
Top Distance between Tape Edges	W_6	3	Maximum
Sprocket Hole Position	W_5	9	-0.5/+0.75
Sprocket Hole Diameter	D_0	4	± 0.2
Abscissa to Plane (Straight Lead)	Н	18.5	± 2.5
Abscissa to Plane (Kinked Lead) (RHEF050 to RHEF1500)	H _o	16.0	± 0.5
Abscissa to Top (RHEF050 to RHEF450)	H ₁	32.2	Maximum
Abscissa to Top* (RHEF550 to RHEF1500)	H ₁	45.0	Maximum
Overall Width with Lead Protrusion (RHEF050 to RHEF450)	C ₁	43.2	Maximum
Overall Width with Lead Protrusion (RHEF550 to RHEF1500)	C ₁	55	Maximum
Overall Width without Lead Protrusion (RHEF050 to RHEF450)	C_2	42.5	Maximum
Overall Width without Lead Protrusion (RHEF550 to RHEF1500)	C_2	54	Maximum
Lead Protrusion	L ₁	1.0	Maximum
Protrusion of Cut-out	L	11	Maximum
Protrusion beyond Hold-down Tape		Not Specified	_
Sprocket Hole Pitch	P ₀	12.7	± 0.3
Device Pitch (RHEF050 to RHEF600)	_	25.4	± 0.61
Device Pitch (RHEF650 to RHEF1500)	_	25.4	± 0.6
Pitch Tolerance	_	20 Consecutive	± 1
Tape Thickness	Т	0.9	Maximum
Overall Tape and Lead Thickness* (RHEF050 to RHEF1100)	T ₁	2.0	Maximum
Overall Tape and Lead Thickness* (RHEF1300 to RHEF1500)	T ₁	2.3	Maximum
Splice Sprocket Hole Alignment	_	0	± 0.3
Body Lateral Deviation	h	0	± 1.0
Body Tape Plane Deviation	р	0	± 1.3
Ordinate to Adjacent Component Lead (RHEF050 to RHEF900)	P ₁	3.81	± 0.7
Ordinate to Adjacent Component Lead (RHEF1000 to RHEF1500)	P ₁	7.62	± 0.7
Lead Spacing* (RHEF050 to RHEF900)	F	5.05	± 0.75
Lead Spacing* (RHEF1000 to RHEF1500)	F	10.15	± 0.75
Reel Width (RHEF050 to RHEF450)	W_2	56.0	Maximum
Reel Width* (RHEF550 to RHEF1500)	W_2	63.5	Maximum
Reel Diameter	А	370.0	Maximum
Space between Flanges* (RHEF050 to RHEF450)	W_1	48.0	Maximum
Space between Flanges* (RHEF550 to RHEF1500)	W_1	55.0	Maximum
Arbor Hold Diameter	С	26.0	± 12.0
Core Diameter*	N	91.0	Maximum
Box	_	64/372/362	Maximum
Consecutive Missing Places	_	None	_
Empty Places per Reel	_	0.1%	Maximum

^{*}Differs from EIA specification.



Tape and Reel Diagrams



Warning

- Users should independently evaluate the suitability of and test each product selected for their own application.
- Operation beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- These devices are intended for protection against damage caused by occasional overcurrent or overtemperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Contamination of the PPTC material with certain silicone-based oils or some aggressive solvents can adversely impact the performance of the devices.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical
 procedures for electronic components.
- PPTC devices are not recommended for installation in applications where the device is constrained such that its PTC properties are inhibited, for example in
 rigid potting materials or in rigid housings, which lack adequate clearance to accommodate device expansion.
- Operation in circuits with a large inductance can generate a circuit voltage (Ldi/dt) above the rated voltage of the device.

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